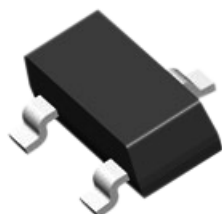
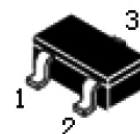
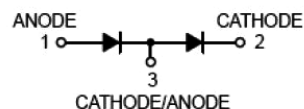


Dual Series Switching Diode



Features:

- Fast Switching Speed
- High Conductance
- Connected In Series
- Surface Mount Package Ideally Suited for Automatic Insertion



SOT-323

Applications:

For general purpose switching application

Max. Rating @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Limits	Unit
Non repetitive peak reverse voltage	V_{RM}	100	V
Repetitive peak reverse voltage Working peak reverse voltage DC reverse voltage	V_{RRM} V_{RMS} V_R	75	V
Peak forward surge current @ $t = 1\text{s}$ @ $t = 1\mu\text{s}$	I_{FSM}	1 2	A
Forward continuous current	I_{FM}	300	mA
Average rectified output current	I_O	150	mA
Power dissipation	P_D	200	mW
Junction and storage temperature	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Conditions	Min.	Max.	Unit
Reverse voltage leakage current	I_R	$V_R = 75\text{V}$ $V_R = 20\text{V}$	-	2.5 25	A nA
Forward voltage	V_F	$I_F = 1\text{mA}$ $I_F = 10\text{mA}$ $I_F = 50\text{mA}$ $I_F = 150\text{mA}$	-	715 855 1,000 1,250	mV
Junction capacitance	C_J	$V_R = 0\text{V}, f = 1\text{MHz}$	-	2	V
Reverse recovery time	t_{rr}	$I_F = I_R = 10\text{mA}$, $V_R = 5\text{V}, R_C = 100\Omega$	-	4	ns

Dual Series Switching Diode

Typical Characteristics @ $T_A = 25^{\circ}\text{C}$ unless otherwise specified

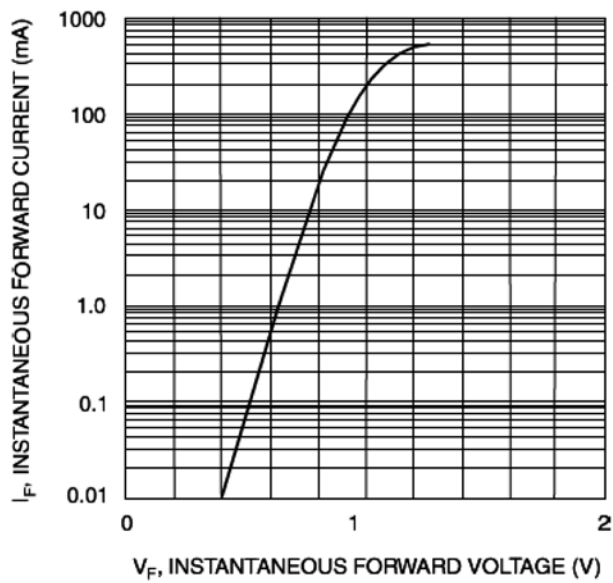


Fig. 1 Forward Characteristics

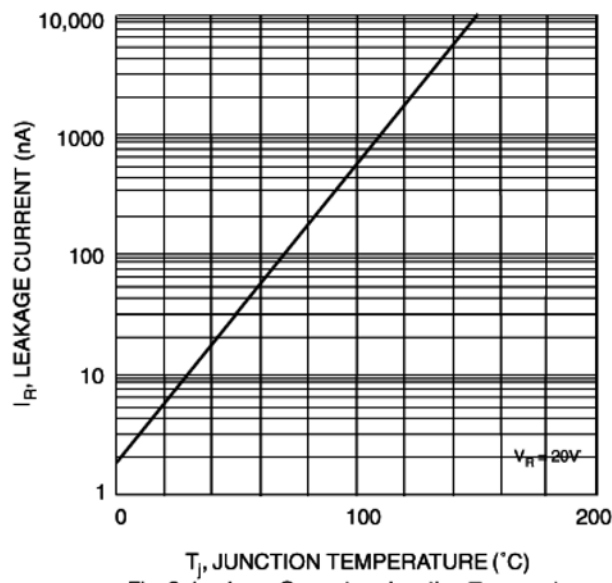
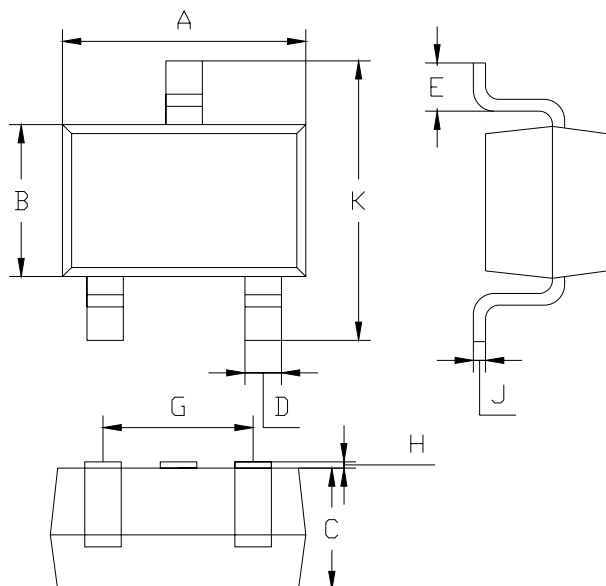


Fig. 2 Leakage Current vs Junction Temperature

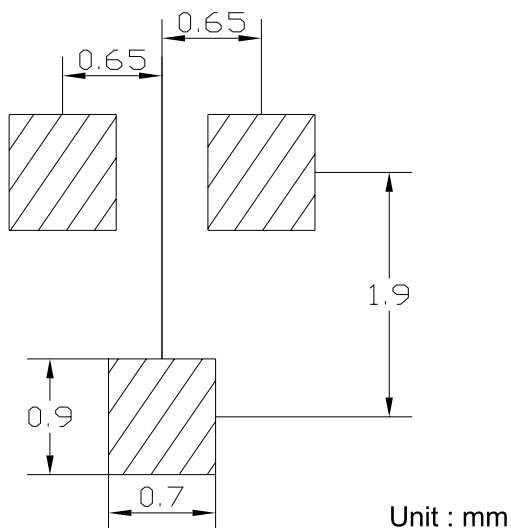
Plastic surface mounted package



SOT-323		
Dim	Min	Max
A	1.8	2.2
B	1.15	1.35
C	1 Typical	
D	0.15	0.35
E	0.25	0.4
G	1.2	1.4
H	0.02	0.1
J	0.1 Typical	
K	2.1	2.3
All Dimensions in mm		

Dual Series Switching Diode

Soldering Footprint



Package Information

Device	Package	Shipping
BAV99W-7-F	SOT-323	3,000 / Tape & Reel

Part Number Table

Description	Part Number
Dual series switching diode	BAV99W-7-F

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